



# SPP4435

## P-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPP4435 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

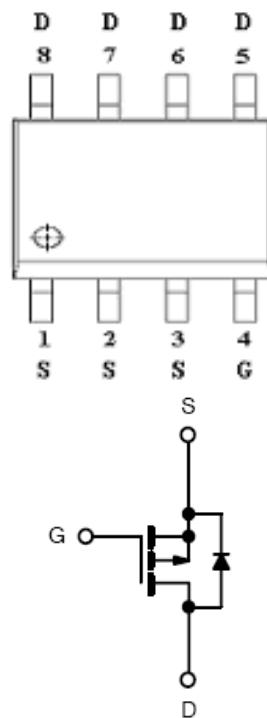
### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### FEATURES

- ◆ -30V/-9.2A,R<sub>DS(ON)</sub>= 25mΩ@V<sub>GS</sub>=- 10V
- ◆ -30V/-7.0A,R<sub>DS(ON)</sub>= 35mΩ@V<sub>GS</sub>=-4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP – 8P package design

### PIN CONFIGURATION(SOP – 8P)



### PART MARKING



A : Lot Code  
B : Date Code



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### PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPP4435S8RG	SOP- 8P	SPP4435
SPP4435S8RGB	SOP- 8P	SPP4435

※ SPP4435S8RG : 13" Tape Reel ; Pb – Free

※ SPP4435S8RGB : 13" Tape Reel ; Pb – Free; Halogen – Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	-30	V	
Gate –Source Voltage	V <sub>GSS</sub>	±20	V	
Continuous Drain Current(T <sub>J</sub> =150°C)	T <sub>A</sub> =25°C T <sub>A</sub> =70°C	ID	-10.0 -7.0	A
Pulsed Drain Current		ID <sub>M</sub>		
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	-2.3	A	
Power Dissipation	T <sub>A</sub> =25°C T <sub>c</sub> =25°C T <sub>A</sub> =70°C	P <sub>D</sub>	2.8 5.3 1.8	W
Operating Junction Temperature	T <sub>J</sub>			
Storage Temperature Range	T <sub>STG</sub>			
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	70	°C/W	



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### ELECTRICAL CHARACTERISTICS

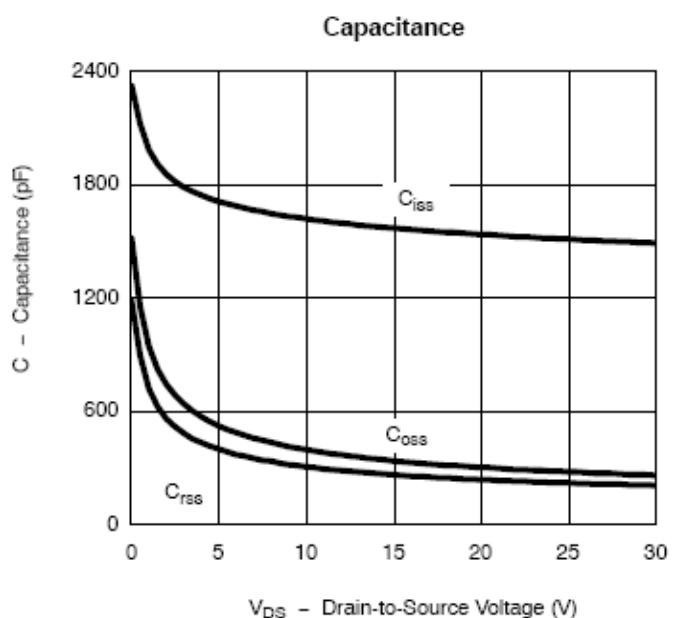
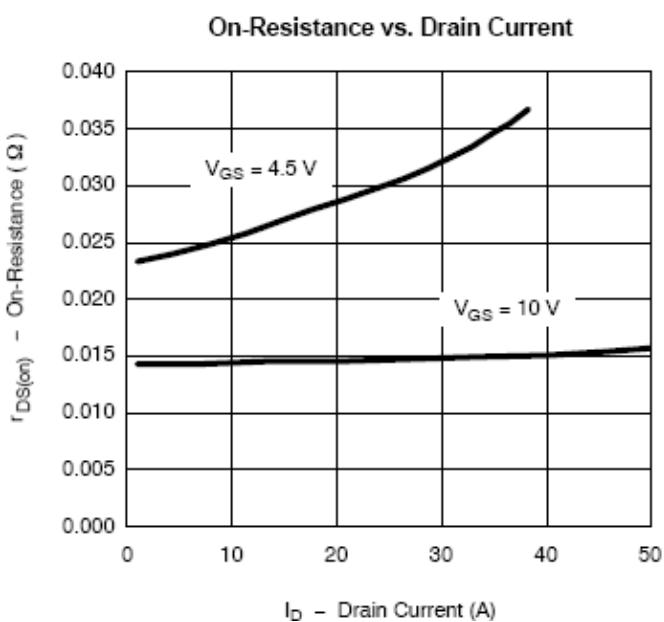
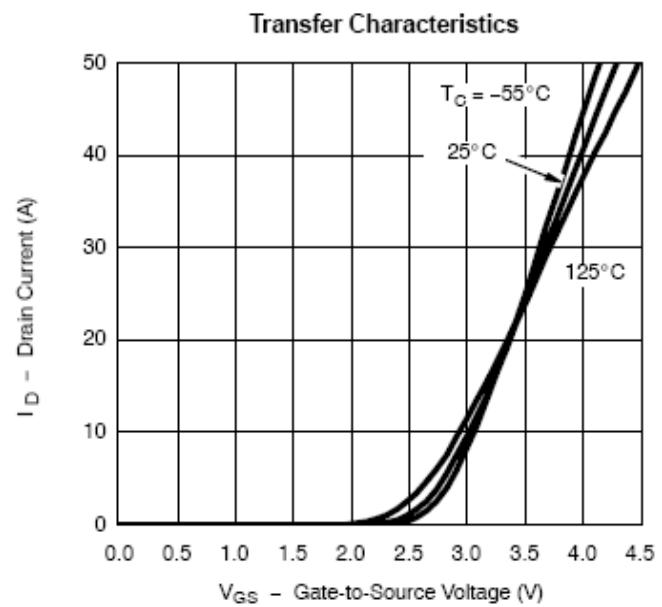
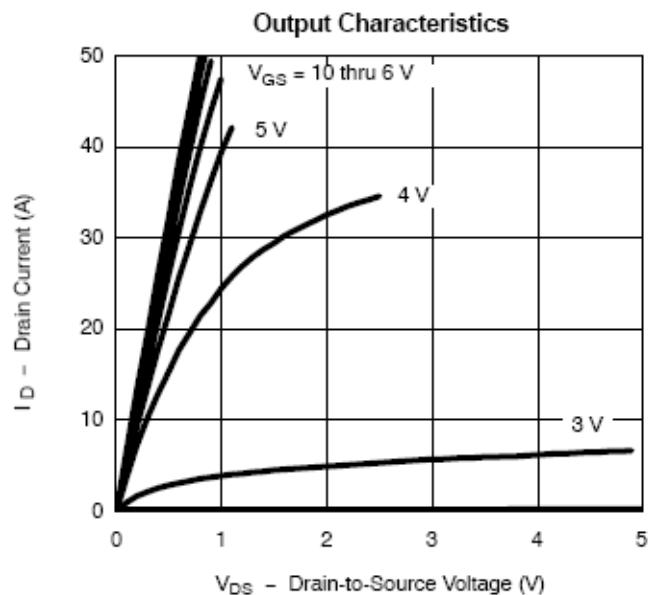
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=-250uA	-30			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , ID=-250uA	-1.0		-3.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V			-1	
		V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			-5	uA
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> = -5V, V <sub>GS</sub> =-4.5V	-40			A
Drain-Source On-Resistance	R <sub>DSS(on)</sub>	V <sub>GS</sub> =-10V, ID=-9.2A		0.022	0.025	
		V <sub>GS</sub> =-4.5V, ID=-7.0A		0.030	0.035	Ω
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-10V, ID=-9.0A		24		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-2.3A, V <sub>GS</sub> =0V		-0.8	-1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V ID= -9.0A		16	24	
Gate-Source Charge	Q <sub>gs</sub>			2.3		nC
Gate-Drain Charge	Q <sub>gd</sub>			4.5		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V f=1MHz		1650		
Output Capacitance	C <sub>oss</sub>			350		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			235		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-15V, R <sub>L</sub> =15Ω ID=-1.0A, V <sub>GEN</sub> =-10V R <sub>G</sub> =6Ω		16	30	
	t <sub>r</sub>			17	30	nS
Turn-Off Time	t <sub>d(off)</sub>			65	110	
	t <sub>f</sub>			35	80	



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## TYPICAL CHARACTERISTICS

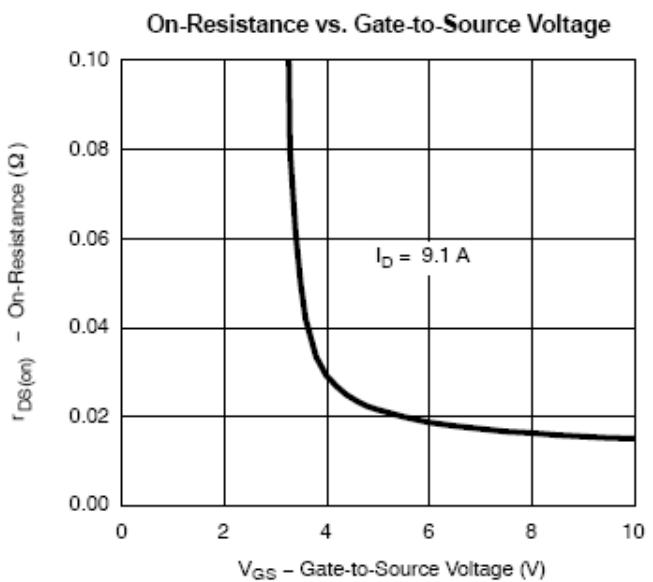
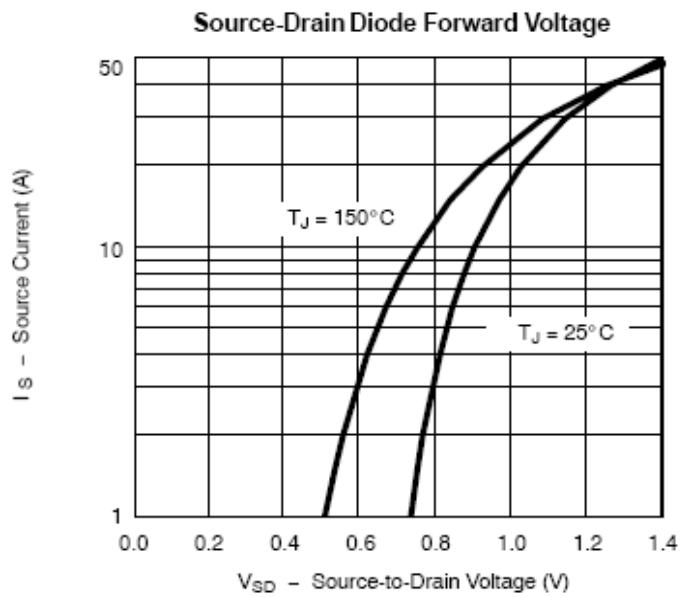
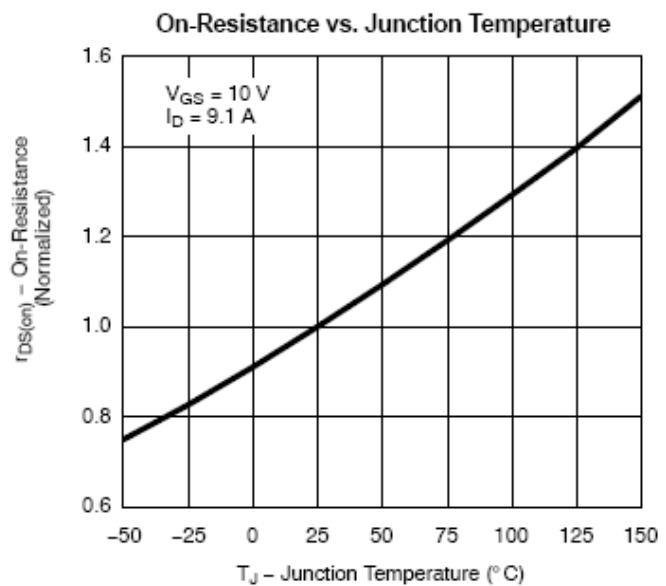
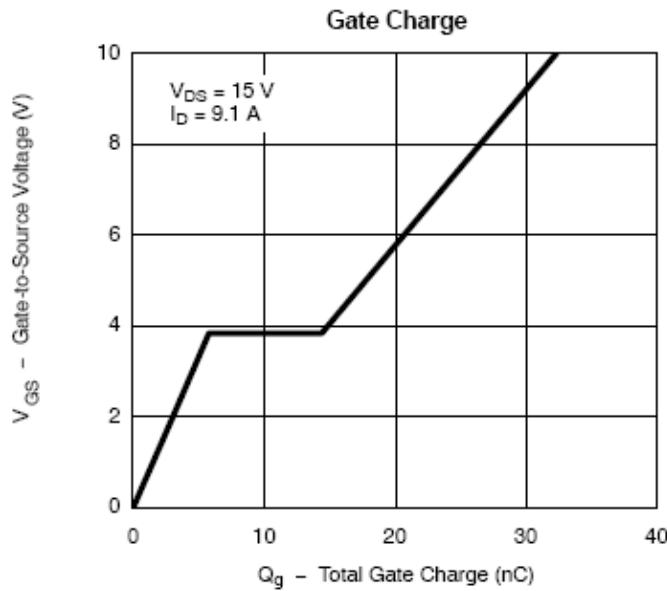




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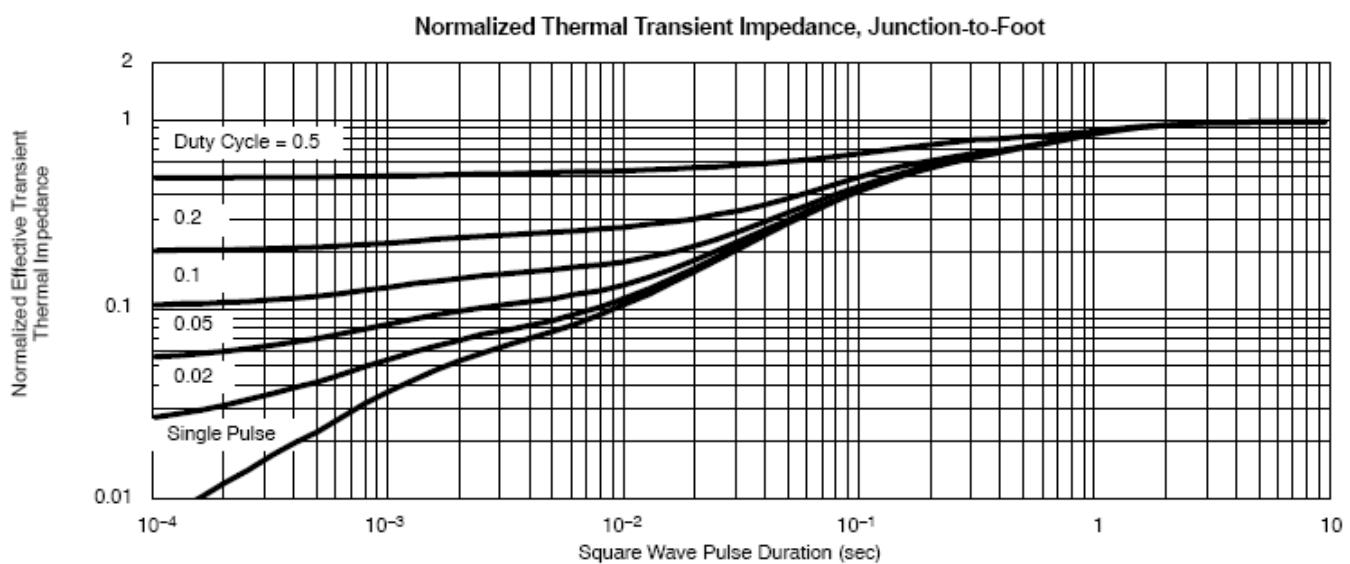
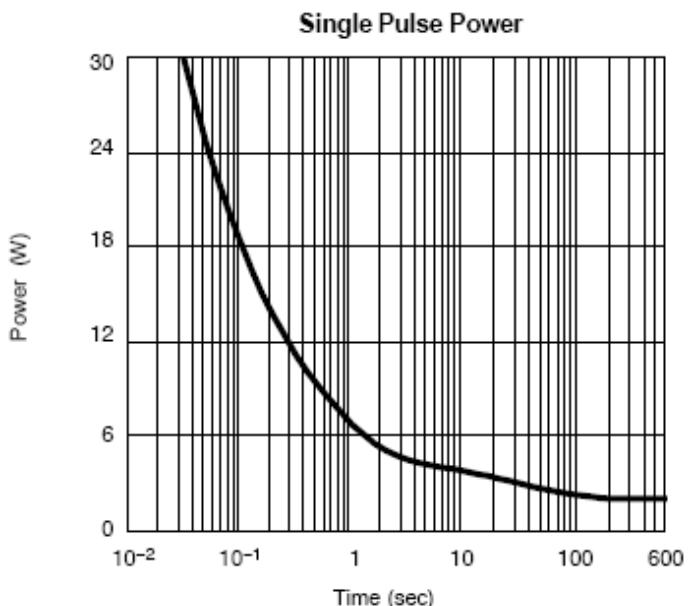
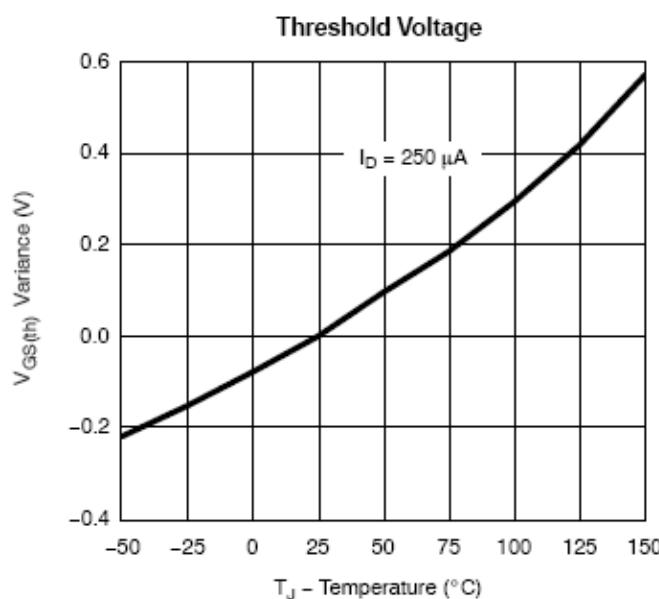




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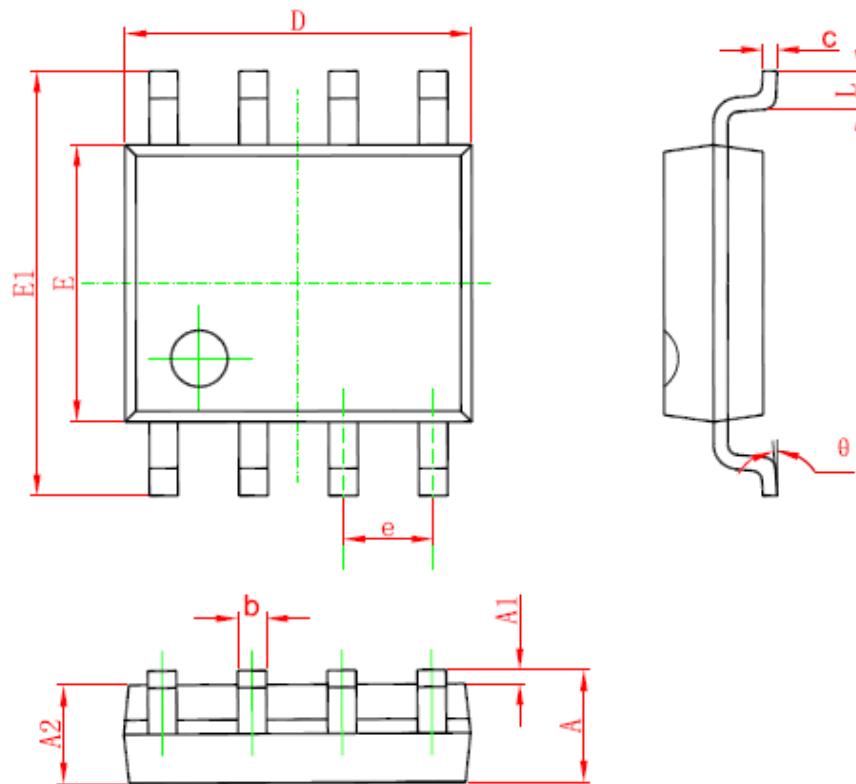




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### SOP- 8 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
$\theta$	$0^\circ$	$8^\circ$	$0^\circ$	$8^\circ$



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